

**COMPOUND DISPERSING AGENT, MIXED ELECTROPLATING
SOLUTION AND USE**

ABSTRACT

Disclosed in the present disclosure are a compound dispersing agent, a mixed
5 electroplating solution and the use. The compound dispersing agent includes a
first anionic surfactant, a second anionic surfactant and a nonionic surfactant,
where the first anionic surfactant comprises sulfonate compounds; and/or the
second anionic surfactant comprises one or more of betaine and carboxylate;
and/or the nonionic surfactant comprises one or more of sulfonated
10 naphthoquinone formaldehyde condensate, melamine-formaldehyde condensate
and sodium methylnaphthalene sulfonic acid formaldehyde condensate.

(No Figure)